

APPARATUS AND METHOD FOR TESTING HIGH CURRENT CIRCUIT ASSEMBLIES

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FIELD OF THE INVENTION

The invention pertains to an apparatus and method for testing circuit assemblies. The apparatus and method are particularly useful for testing low voltage, high current circuit assemblies.

BACKGROUND OF THE INVENTION

In the testing of high current (above 10 Amperes) electronic circuit assemblies it is essential that a good electrical contact be established between the test apparatus test pins and the electronic circuit assembly test points. The electrical test pins must make good mechanical contact and be capable of withstanding high current to ensure low resistance to the test apparatus. While it is desirable to limit contact signal loss at any voltage, low resistance contacts are particularly advantageous at low voltages. At low voltages (below 5 volts) the loss of a substantial part of the available test signal voltage through test contacts can cause the test to fail. Additionally, for fast and flexible testing in various environments including, production, laboratory, burn-in, and repair, these connections need to be quickly established and quickly released.

Conventional circuit assembly test fixtures incorporate a test bed to make electrical contact at a plurality of points to the circuit assembly under test. The mechanical test probes in the test bed, called test pins, are used to make electrical contact with the circuit assembly at each circuit assembly test point, usually an exposed metal or solder tinned surface area, referred to as a pad.

When the circuit assembly is mounted in the test fixture, each test pin to contact pad connection can be characterized by electrical parameters. The resistance and inductance of the test connection are of particular interest for low voltage, high current signal test points where it is desirable to minimize both of these parameters.

As circuit assemblies to be tested are inserted and removed from the test bed, test pins must repeatedly make reliable mechanical and electrical connection between the test pins and the appropriate contact pads on the circuit assembly under test. These connections are made many times, particularly in the case of automatic test equipment.

Conventional test points incorporate a mechanical means to make and maintain contact with circuit assemblies of varying mechanical tolerances. Such test points, known as compliant test points, incorporate a sliding plunger supported by a spring in a hollow test point receptacle base. Each time a circuit assembly is placed in the test bed, the spring compresses as necessary to make mechanical contact between the compliant test pin and the test point contact pad. Referring to the drawings, Fig. 1 shows a test fixture 10 based on prior art compliant pins. Circuit assembly 12 is held in place by flange 11. The sliding plunger pins 14 extend to contact the circuit assembly pads 13.

Sliding plunger pin 14 is held against a test point pad 13 by the small force of spring 15, residing in the compliant pin hollow test point receptacle base 16. Since the spring 15 is located inside the hollow test pin base 16, it must be relatively small. Because of its small size, the internal spring 15 applies only a small force to the test pin 14. This small contact force results in a higher contact resistance than would be obtained with a stronger spring force.

In addition to the contact force, the resistance and inductance of the test connection are a function of the physical structure of the compliant pin. There are two electrical conduction paths within the structure of a compliant pin. The first is the direct path through any overlapping regions of the hollow cylindrical structure of the base receptacle and the plunger test pin. The second path is from the base receptacle through the spring to the test point. In parallel circuits,

the combined resistance and inductance is lower than the either path alone, but the net resistance and inductance of this structure is still relatively high due to its small physical size.

An additional problem with the compliant test pin is that the quality of the electrical connection deteriorates as spring and sliding plunger mechanically cycle with test circuit assembly insertion and removal. The increase in resistance is due to both a reduction in test pin spring force due to annealing and the deterioration of the surface contact between the test pin spring and the hollow base receptacle, and between the base receptacle and the test pin. Eventually, the resistance and inductance rises to a point where the voltage drop developed at the connection is so high that it precludes further testing without replacement of the failed compliant pin.

Accordingly, a need exists for a test instrument having low voltage, high current test pins that provide relatively constant low resistances and inductances that are stable over time and do not deteriorate with insertion cycles.

SUMMARY OF THE INVENTION

The invention is a test apparatus incorporating high current test pins, forced into contact with a circuit assembly under test by opposing compliant pressure pins. An advantageous test pin for low voltage, high current testing is a solid, one piece test pin. The solid test pin, when supplied with adequate contact force, provides both low resistance and low inductance. The required compliant force is applied to the test circuit, opposite and substantially in line with the solid test pin, by a compliant pressure pin. Since the test pin does not supply the compliant force, it can be designed primarily for the desired electrical parameters of the test contact. The only mechanical considerations for the conductive solid pin are the amount of desired surface contact area, the dominant mechanical parameter in setting the contact resistance, and the body dimensions, which determine the resistance and inductance of the pin itself. Since the opposing

compliant pressure pin is not part of the electrical test circuit, it can be designed for its mechanical properties alone. The advantage of the conductive pin - compliant pressure pin pair over the prior art compliant pin is that the compliant element, usually a spring, is no longer part of the test circuit. Also, a much higher contact force is achievable, resulting in significantly lower contact resistance.

BRIEF DESCRIPTION OF THE DRAWINGS

The advantages, nature and various additional features of the invention will appear more fully upon consideration of the illustrative embodiments now to be described in detail in connection with the accompanying drawings. In the drawings:

FIG. 1 depicts a prior art test apparatus;

FIG. 2 depicts a test apparatus in accordance with a first embodiment of the invention;

FIG. 3 is a perspective view of a conductive pin useful in the apparatus of Fig. 2;

FIG. 3A is a side view of the pin in FIG. 3;

FIG. 4 is a perspective view of a compliant pressure pin useful in the apparatus of FIG. 2;

FIG. 4A is a cut-away side view of the pin in FIG. 4;

FIG. 5 is a perspective view of an embodiment of the invention in a clamp type test fixture;

FIG. 5A is a side view of FIG. 5;

FIG. 6 is a perspective view of a second embodiment of the invention in a press type test fixture; and

FIG. 6A is a side view of FIG. 6.

It is to be understood that these drawings are for purposes of illustrating the concepts of the invention and are not to scale.

DETAILED DESCRIPTION

Referring to the drawings, Fig. 2 shows a test fixture apparatus 20 comprising a plurality of conductive pins 23 (three shown here) and corresponding compliant pressure pins 21. The conductive pins are advantageously solid, unitary metal pins. The conductive pins 23 make contact with the corresponding test point contact pads 22 that are part of the circuit assembly under test 25. Additional low current test points can be contacted by conventional compliant test points 24. The conductive pins 23 can be mounted in a base member. The base member can be insulating or alternatively, the pins 23 can be coated, or covered with insulation to isolate the individual test circuits.

Fig. 3 is a perspective view showing a conductive high current test pin 23 useful in the apparatus of Fig. 2. Conductive pin contact surface 30 is of sufficient surface area for the desired contact resistance. Fig. 3A, a side view of a conductive pin, shows optional shoulders 31 used to locate the pin in the test fixture and in the test circuit assembly. The conductive pin is advantageously a conductive metal, typically gold or silver plated brass or copper, or silver plated nickel, but may be composed of other conductive materials or materials with a conductive plating.

Fig. 4 is a perspective view showing a compliant pressure pin 21 useful in the apparatus of Fig. 2. Compliant pin pressure surface 40 holds the circuit assembly under test against the corresponding contact surface of a conductive pin 23. Fig. 4A is a side view of the compliant pressure pin depicted in Fig. 4, showing an embodiment where the compliant member is a spring 43, which applies pressure to plunger 44 with pressure surface 45 that acts on the circuit

assembly under test. A retainer **41** supports a resilient element, here spring **43**. The resilient element can also be made of resilient materials such as rubber. The compliant pressure pin base **42** is typically a plastic, thermoplastic, nylon, epoxy, glass epoxy, or metal, but is not limited to those materials. The compliant pressure pins are not a part of the electrical test circuit, therefore their electrical parameters need not be considered. In some embodiments, it may be desirable to avoid ferrous materials, so as to minimize the inductance of various nearby structures in the test circuits.

The resistance of the conductive pin **23** to test circuit assembly pad **22** is typically in the range from .1 to .5 milliohms, depending on the surface area of the contact surface of the pad, the contact force caused by the opposing compliant pressure pin **21**, and the physical dimensions of pin **23**. The inductance of the conductive pin **23** is typically in the range of 2 to 10 nanohenrys.

Fig. 5 shows a clamp type embodiment of the inventive test apparatus **500**. The test fixture cover is hinged by hinges **503**, and a plate, holding the compliant pressure pins **21**, is held in a closed position for testing by latches **504** and pins **501**. The latches **504** are held closed by springs **505**. The latches **504** are released by lever **502**, to remove the test circuit assembly.

Fig. 5A shows a side view of the Fig. 5 embodiment. Here, the plate is supported above the test fixture top cover, supported on posts **551**. When the lever **502** is closed, cam **552** lowers the plate into place and is held locked by springs **553**. In this embodiment, the compliant force applied to hold the circuit assembly under test to the corresponding stationary pin is applied by the resilient elements in the compliant test pins **21** and not by springs **553**.

Fig. 6 shows a press type embodiment of the inventive test apparatus **600** with a plurality of compliant pressure pins (here four) **21** held in plate **602** and a plurality of holes **603** (only one of which is unobstructed and shown in this view) as an optional means for locating conductive test pins (not shown). Here, press handle **601** lowers the plate, applying force to the test circuit to press its contact pads (not shown) onto the corresponding stationary test pins (not shown) as illustrated in Fig. 2. Fig. 6A shows a side view of Fig. 6. In this embodiment, the compliant

pressure pins 21 are optionally mounted by their base element in holes 651 sized to accept the pins 21, and affixed in place by set screws 650 normal to the base element.

The invention can now be understood more clearly by consideration of the following specific embodiment.

Example

In the preferred application, the circuit assembly under test is a small rigid printed circuit board. In this case, the number of conductive high current test points that can be used is in the range of one to three. There is a maximum number of three conductive points because the rigid board will sit in the plane established by the height of the three non-collinear points, with any remaining standard test point locations being satisfied by conventional compliant pins. Conventional pins are then employed for additional low current test points and extend as needed to make contact with low current test points that fall in the plane in which the board sits as suspended by the conductive pins.

In a specific embodiment, the conductive pins as shown in Figs. 3 and 3A were made of brass plated with nickel followed by gold. The axial length of each pin extending between the circuit assembly under test and the test apparatus was 0.610 inches. The diameter of the pin ranged from 0.062 inches to 0.125 inches. The resistance of the pin was 0.3 milliohms and the inductance was 8 nanohenrys.

In other embodiments, a plurality of more than 3 pins may be used. One such embodiment is where the circuit board under test is a flexible, as opposed to a solid structure. Another embodiment allowing more than 3 conductive pins is where the board is large enough such that for the material the board is constructed of it can flex enough to allow multiple planes of stationary pins. An example is a long and narrow circuit board with low voltage, high current test points at both ends of the board.

In some embodiments of the invention, the circuit assembly under test is oriented in planes other than horizontal. In this case a base member in a plane other than the horizontal, supports, or incorporates as integral parts, a plurality of conductive test pins. A plate in a plane essentially parallel to the base then supports, or incorporates as integral parts, the corresponding compliant pressure pins. The test fixture and circuit assembly under test may be oriented and operated in any plane in space.

It is understood that the above-described embodiments are illustrative of only a few of the many possible specific embodiments, which can represent applications of the invention. Numerous and varied other arrangements can be made by those skilled in the art without departing from the spirit and scope of the invention.

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